



PSR-4000 CC01SE

(UL Name: PSR-4000JV / CA-40JV)

LIQUID PHOTOIMAGEABLE SOLDER MASK

- **©** Curtain Coat and Spray Application
- Available in a DI version to work on the latest DI equipment
- Aqueous Developing Solder Mask
- **RoHS Compliant**
- **W** Halogen-Free
- **©** Compatible with Lead-Free Processing
- **Wide Processing Window**
- **Excellent Resistance to ENIG & Immersion Tin**
- Resistant to Hot Storage
- **Conforms to IPC SM-840E Requirements**
- **Compatible to LASER Marking**

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PROCESSING PARAMETERS FOR PSR-4000 CC01SE

PSR-4000 CC01SE COMPONENTS:

		PSR-4000 CC01SE Matte or Semi-Matte / CA-40 CC01					
	Mixing Ra Color	atio		80 parts Green		20 parts White	
	Mixed Pr	roperties					
	Solids Viscosity Specific G		81% 185 – 22 1.32	5 ps			
Mixing	we Fc ar sp wi	eight of 80 parts or Curtain Coat nd hardener. P peeds to minimi	s, PSR-4000 (and Spray, P SR-4000 CC ize shear thin ddition should	CC01SE and MA solvent is D1SE can be ning for 10 –	20 parts, CA added at 20 mixed a mo 15 minutes.	ners with a mix ratio b -40 CC01SE TR60817 0-25%, of the mixed in echanical mixer at lo The resulting viscosit econds in a Ford #4 o	7. nk w ty
PRE-CLEANING	cle Me re ap	eaned. Variou lechanical Brusl ecommended.	is cleaning h, and Chemic All of these SR-4000 CC0 1	methods inc cal Clean. For methods will SE. Hold tim	clude Pumic full body go provide a le after clean	rd surface needs to b ce, Aluminum Oxide ld an alkaline cleaner i clean surface for th ing the PCB should b surfaces.	e, is ie
SPRAY APPLIC	sp ex ps Pr re	oray atomization xceed 35 psi add si and repeat pr ressure to get equirements. lethod: HVLP sp • Needle Se • Gun temp • Atomizatio	a pressure unt d additional sol rocess until yo the desired s prayer et: 5 – 6 turns perature: 90 - 7 on air tempera	il you have a lvent and rese ou get a smo older mask t out 100°C ature: 90 - 100	smooth non to the atomiza ooth sprayed hickness tha	ay a panel. Increase th -mottled surface. If yo tion pressure back to 3 surface. Adjust the Po t meets your coverag	ou 60 ot



- Atomization Pressure: 30-35 psi, start at the low setting and increase until there is no mottling
- Conveyor speed: 2.5 3.0 ft./min; as slow as production allows

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CURTAIN COATING	Method: Single Sided Coating		
	 Temperature: 24°C 		
	 Slot Width: 0.4 0.5 mm 		

- Slot Width: 0.4 0.5 mm
- Belt Speed: 70 100 m/min
- Wet Weight: 85 140 grams/m²

TACK DRY CYCLEThe Tack Dry step is required to remove solvent from the solder mask film and
produce a firm dry surface. The optimum dwell time and oven temperature will
depend on oven type, oven loading, air circulation, exhaust rate, and ramp times.
Excessive tack dry times and temperature will result in difficulty developing solder
mask from through holes and a reduction in photo speed. Insufficient tack dry will
result in artwork marking and/or sticking. Typical tack dry conditions for PSR-
4000 CC01SE are as follows:

- Oven Type: Conventional Batch or Conveyor
- Oven Temperature: 66 80°C (150 176°F)
- For Single-Sided (Batch Oven)
 - 1st Side: Dwell Time: 15 20 minutes
 - 2nd Side: Dwell Time: 15 40 minutes
- For Double-Sided (Batch or Conveyor)
- Dwell Time: 30 60 minutes
- Oven Type: IR or IR assisted
 - Conveyor Speed: 2.7 3.2 ft./min
 - Time above 80° C: 2 2.1 minutes
 - Maximum Peak Temperature: 115°C
 - Total Dwell Time: 3 6 minutes

EXPOSURE

PSR-4000 CC01SE was designed to work on the latest DI equipment. It requires UV exposure to define solder mask dams and features. The spectral sensitivity of **PSR-4000 CC01SE** is in the area of 365 nm. Exposure times will vary by bulb type, age of the bulb and light source type. Below are guidelines for exposing **PSR-4000 CC01SE** using the latest DI equipment.

- Exposure Unit: 8 kW or higher
- Stouffer Step 21: Clear 8 minimum (on metal / under phototool)
- Energy: 90 150 mJ / cm² minimum (under phototool)

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DEVELOPMENT	 PSR-4000 CC01SE is developed in an aqueous sodium or potassium carbonate solution. Developing can be done in either a horizontal or vertical machine. Solution: 1% by wt. Sodium Carbonate or 1.2% Potassium Carbonate pH: 10.6 or greater Temperature: 85 - 95°F (29 - 35°C) Spray Pressure: 25 - 45 psi (1.7 - 3.1 bars) Dwell Time in developing chamber: 45 - 120 seconds Water rinse is needed to remove developer solution followed by a drying step
FINAL CURE	 PSR-4000 CC01SE requires a thermal cure to insure optimal final property performance. Thermal curing can be done in a batch oven or conveyorized oven. Temperature: 275 - 300°F (135 - 149°C) Time at Temperature: 45 - 60 minutes
UV CURE	To improve moisture and chemical resistance a UV cure of $2 - 3 \text{ J/cm}^2$ is recommended.

For Process Optimization please contact your local Taiyo America Representative

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FINAL PROPERTIES FOR PSR-4000 CC01SE

IPC-SM-840E, Class H & T, Solder Mask Vendor Testing Requirements

TEST	SM-840 PARAGRAPH	REQUIREMENT	RESULT
Visual	3.3.1	Uniform in Appearance	Pass
Curing	3.2.5.1	Ref: 3.6.1.1, 3.7.1 and 3.7.2	Pass
Non-Nutrient	3.2.6	Does not contribute to biological growth	Pass
Pencil Hardness	3.5.1	Minimum "F"	Pass – 6H
Adhesion	3.5.2.1	Rigid – Cu, Ni, FR-4	Pass
Adhesion	3.5.2.6	Doubled Layered Solder Mask	Pass
Machinability	3.5.3	No Cracking or Tearing	Pass
Resistance to Solvents and Cleaning Agents	3.6.1.1	Table 3 Solvents	Pass
Hydrolytic Stability and Aging	3.6.2	No Change after 28 days of 95-99°C and 90-98% RH	Pass
Solderability	3.7.1	No Adverse Effect J-STD-003	Pass
Resistance to Solder	3.7.2	No Solder Sticking	Pass
Resistance to Solder	3.7.3	No Solder Sticking	Pass
Simulation of Lead Free Reflow	3.7.3.1	No Solder Sticking	Pass
Dielectric Strength	3.8.1	500 VDC / mil Minimum	3123 VDC/mil (123 VDC / μm)
Thermal Shock	3.9.3	No Blistering, Crazing or De-lamination	Pass

Specific Class "H" Requirements

TEST	SM-840 PARAGRAPH	REQUIREMENT	RESULT
Flammability	3.6.3	UL 94V-0	Pass, File #E166421
Insulation Resistance	3.8.2		
Before Soldering		5 x 10 ⁸ ohms minimum	Pass (2.0 x 10 ¹³ ohms)
After Soldering		5 x 10 ⁸ ohms minimum	Pass (3.2 x 10 ¹³ ohms)
Moisture & Insulation Resistance	3.9.1		
Before Soldering-In Chamber		5 x 10 ⁸ ohms minimum	Pass (3.2 x 10 ¹¹ ohms)
Before Soldering–Out of Chamber		5 x 10 ⁸ ohms minimum	Pass (2.8 x 10 ¹² ohms)
After Soldering-In Chamber		5 x 10 ⁸ ohms minimum	Pass (7.7 x 10 ¹⁰ ohms)
After Soldering-Out of Chamber		5 x 10 ⁸ ohms minimum	Pass (7.6 x 10 ¹² ohms)
Electrochemical Migration	3.9.2	>2.0 x 10 ⁶ ohms, no growth	Pass (1.3 x 10 ¹² ohms)

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FINAL PROPERTIES FOR PSR-4000 CC01SE

Specific Class "T" Requirements

TEST	SM-840 PARAGRAPH	REQUIREMENT	RESULT
Flammability	3.6.3	Bellcore 02 Index – 28 minimum	Pass – 89
Insulation Resistance	3.8.2		
Before Soldering		5 x 10 ⁸ ohms minimum	Pass (1.5 x 10 ¹¹ ohms)
After Soldering		5 x 10 ⁸ ohms minimum	Pass (6.5 x 10 ¹⁰ ohms)

Specific Class "T" Requirements

TEST	SM-840 PARAGRAPH	REQUIREMENT	RESULT
Moisture & Insulation Resistance	3.9.1		
Before Soldering-In Chamber		5 x 10 ⁸ ohms minimum	Pass (1.6 x 10 ⁹ ohms)
Before Soldering–Out of Chamber		5 x 10 ⁸ ohms minimum	Pass (1.8 x 10 ¹³ ohms)
After Soldering-In Chamber		5 x 10 ⁸ ohms minimum	Pass (2.5 x 10 ⁹ ohms)
After Soldering-Out of Chamber		5 x 10 ⁸ ohms minimum	Pass (9.2 x 10 ¹² ohms)
Electrochemical Migration	3.9.2	< 1 decade drop, no dendritic growth	Pass

Additional Tests / Results

TEST	REQUIREMENT	RESULT
Surface Tension after Cure	Internal test; greater than 40 dynes/cm	42
CTI (Comparative Tracking Index)	ASTM-D-3638-07	≥600
Adhesion	GIP-008AA (TAIYO Internal Test Method) Cross-cut tape stripping test	100/100
Solder Heat Resistance	Solder float test: Rosin Flux 300°C/30sec., 1 cycle	Pass
Solvent Resistance	PGM-AC dipping, temp 20°C. / 20 min, Tape peeling test	Pass
Acid Resistance	10 vol% H ₂ SO ₄ , temp 20°C. / 20 min, Tape peeling test	Pass
Alkaline Resistance	10 wt% NaOH, temp 20°C. / 20 min, Tape peeling test	Pass
Electroless Ni/Au	TAIYO Internal Test Method Ni: 3 microns, Au: 0.03 microns	Pass
Immersion Tin Plating resistance	TAIYO internal test method Tin thickness: about 1 um	Pass
Hot Storage Resistance	160°C for 1000 hours – cross hatch adhesion (Mec Etch pretreatment)	Pass

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Hot Storage Resistance

150°C for 2000 hours – cross hatch adhesion (Mechanical Brush pretreatment)

Pass

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Additional Tests / Results		
Legend Ink Adhesion	Tape test: LPI Legend – PSR-4100 WL(HD) Thermal Legend – S-200W UV Legend – UVR-110W Inkjet – IJR-4000 MW300	Pass Pass Pass Pass
Gloss after Final Cure	 Internal test; recorded at 60° angle PSR-4000 CC01SE Matte PSR-4000 CC01SE Semi-Matte 	<19 20 - 30
Conformal Coat Adhesion	Crosshatch adhesion/tape test: Dow Corning 1-2577 (Silicone) Humiseal 1B51 (Synthetic Rubber) Humiseal 1B73 (Acrylic) Humiseal 2A64 (Urethane) Cytec CE 1155 (Urethane)	Pass Pass Pass Pass Pass
Halogen Level	Halogen Free if < 900 ppm	285 ppm
Outgassing Test ASTM E595 A 2 J/cm ² UV Cure was done after thermal cure	TML <u><</u> 1% CVCM <u><</u> 0.10%	TML-0.87% CVCM-<0.01%
Dk / Df	Internal Test at: 1.1 GHz 5.1 GHz 10.0 GHz 19.8 GHz	Dk / Df 3.6 / 0.022 3.6 / 0.021 3.5 / 0.021 3.5 / 0.020
Тд	Internal Test	140°C
CTE	Internal Test	α 1 = 39 ppm α 2 = 99 ppm
Resistance to IPC	Internal Test	Pass
Resistance to Rosin Flux	Internal Test	Pass

Taiyo America, Inc. (TAIYO) warrants its products to be free from defects in materials and workmanship for the specified warranty period **PSR-4000 CC01SE Warranty period is 12 Months** provided the customer has, at all times, stored the ink at a temperature of 25°C or less. TAIYO accepts no responsibility or liability for damages, whether direct, indirect, or consequential, resulting from failure in the performance of its products. If a TAIYO product is found to be defective in material or workmanship, its liability is limited to the purchase price of the product found to be defective. TAIYO MAKES NO OTHER WARRANTY, EXPRESS OR IMPLIED, AND MAKES NO WARRANTY OF MERCHANTABILITY OR OF FITNESS FOR ANY PARTICULAR PURPOSE. TAIYO'S obligation under this warranty shall not include any transportation charges or costs of installation or any liability for direct, indirect, or consequential damages or delay. If requested by TAIYO, products for which a warranty claim is made are to be returned transportation prepaid to TAIYO'S factory. Any improper use or any alteration of TAIYO'S product by the customer, as in TAIYO'S judgment affects the product materially and adversely, shall void this limited warranty.

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FINAL PROPERTIES FOR PSR-4000 CC01SE

Hot Storage Photographs: 200°C for 250, 500, 1000 and 2000 hours – cross hatch adhesion (Mechanical Brush pretreatment). No cracking at the corners.

Photo 1: after 250 hours over copper



Photo 3: after 500 hours over copper



Photo 5: after 1000 hours over copper



Photo 7: after 2000 hours over copper



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Photo 2: after 250 hours over FR4 laminate



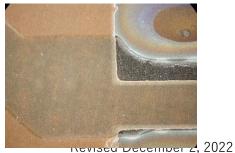
Photo 4: after 500 hours over FR4 laminate



Photo 6: after 1000 hours over FR4 laminate



Photo 8: after 2000 hours over FR4 laminate







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Legend Ink Adhesion: PSR-4000 CC01SE was coated with various types of Taiyo legend ink. Below are photos after tape testing of LPI, Thermal Cure, UV Cure and Inkjet.



Photo 9: LPI Legend, PSR-4100WL (HD)

Photo 10: Thermal Cure Legend, S-200W

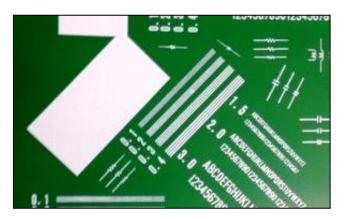


Photo 11: UV Cure Legend, UVR-110W

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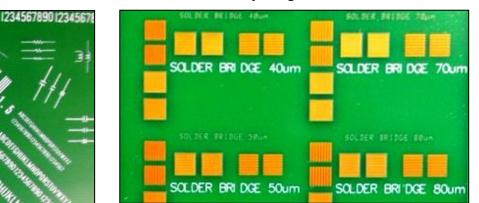


Photo 12: Inkjet Legend, IJR-4000 MW300

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